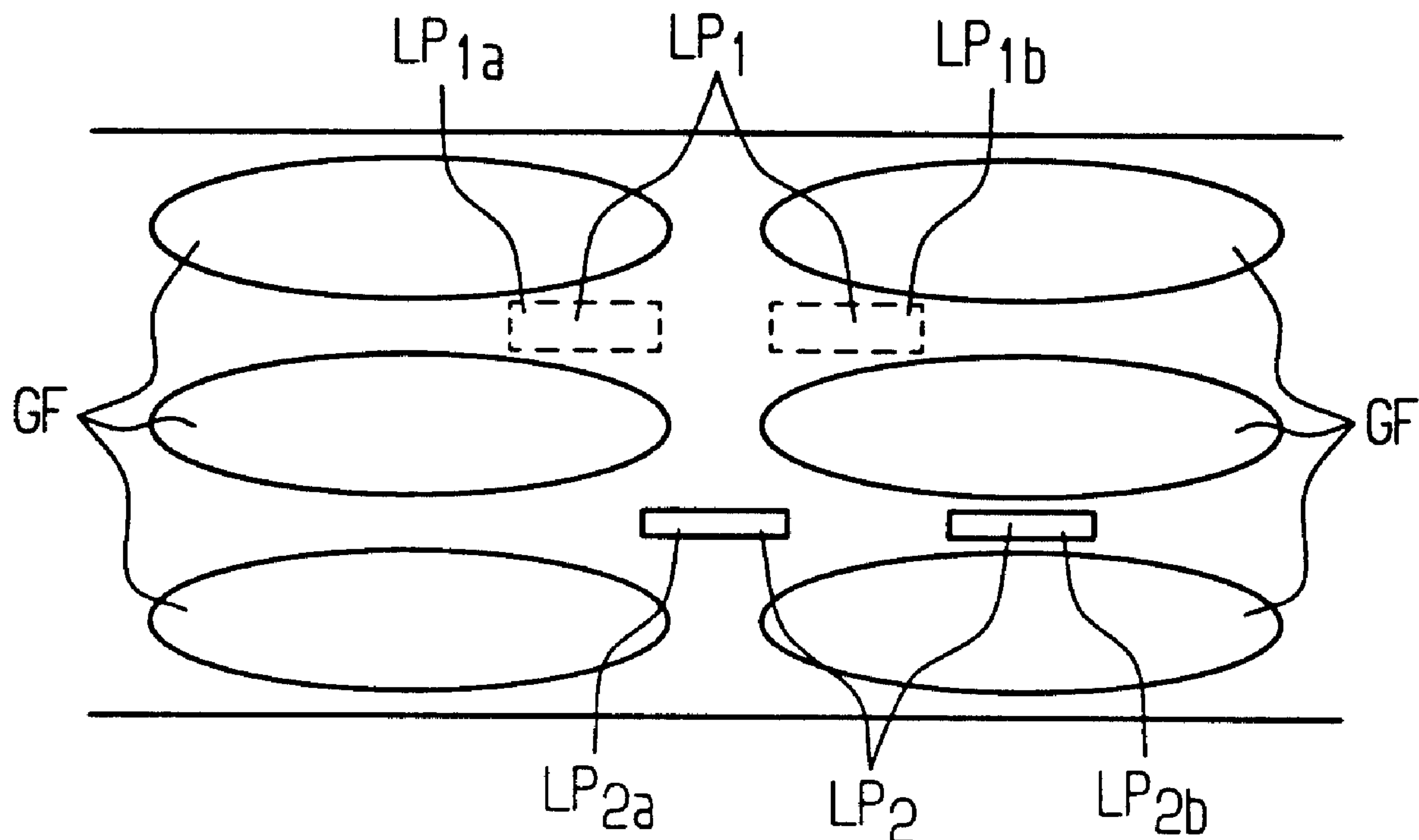




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(72) Inventeurs/Inventors:
BRAND, UWE, DE;
TSCHERNITZ, MAXIMILIAN, DE;
STEINHAUSER, KARL-AUGUST, DE
(73) Propriétaire/Owner:
SIEMENS AKTIENGESELLSCHAFT, DE
(74) Agent: FETHERSTONHAUGH & CO.

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(54) Title: DEVICE FOR TRANSMITTING HIGH-FREQUENCY SIGNALS



(57) Abrégé/Abstract:

In the prior art, the transmission of high-frequency signals over data lines which are fixed on conventional printed boards entails the problem that the different materials used there condition different signal transit times. The reason for this is that the data lines are led parallel to the optical fiber bundles which form the printed board. According to the invention, care is taken that the data lines are led at a specific angle to the optical fiber bundles.

Abstract

Device for transmitting high-frequency signals.

- 5 In the prior art, the transmission of high-frequency signals over data lines which are fixed on conventional printed boards entails the problem that the different materials used there condition different signal transit times. The reason for this is that the data lines are led parallel to the optical fiber bundles which form the printed board. According to the invention, care is taken that the data lines are led at a specific angle
- 10 to the optical fiber bundles.

**FILE, ~~PH~~ IN THIS AMENDED
~~TEXT~~ TRANSLATION**

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DEVICE FOR TRANSMITTING HIGH-FREQUENCY SIGNALS

The invention relates to a device as claimed in the preamble of patent claim 1.

5 In communication systems it is increasingly required to transmit and process electrical signals at a very high rate. The electrical signals are formed here as control signals and/or communication signals, in particular. Particularly in communication signals which are transmitted in a synchronous transfer mode (ATM), transmission rates of up to 830 MBit/s can arise. But problems arise in the processing of such high
10 transmission speeds which were unknown in the transmission of data at low speeds.

In general, the transmission of signals entails the problem that electrical signals which are transmitted on lines residing in close proximity to one another, usually on copper cables, couple electromagnetically. At lower frequencies, electromagnetic coupling of
15 the communication signals running on the copper cables does not occur, or respectively, is insignificant. However, given ever higher transmission frequencies, such a coupling can no longer be avoided. Couplings result in electromagnetic interference, for example. A suitable shielding could help in this regard, but to take this course of action on every cable in the communication system would be
20 uneconomical.

Therefore, in order to keep potential couplings to a minimum, a complementary transmission of the communication signals via a data line is desired. This line is formed by a cable pair.

25

This means that one pulse train is transmitted over one of the lines of the cable pair, while the complementary pulse train is transmitted over the other line of the cable pair. Here, a possible crosstalk of signals that are transmitted over neighboring lines causes disturbances on both lines in the same manner. These are then averaged out again at

the receive side by forming difference signals. This type of data transmission thus has a relatively high protection against potentially arising interference.

The assemblies or printed circuit boards of longstanding use in communication systems
5 comprise connecting structures in the prior art, where copper tracks run parallel to the edge of the respective printed board (edge-parallel). The relevant electrical signals are then emitted via these copper tracks.

The printed boards used are produced from a material comprising a glass mat. The
10 glass mats themselves consist of individual optical fiber bundles which are soaked in resin and fashioned into a web structure. Copper tracks run at the surface of a glass mat that is formed in this way, via which the electrical signals are conducted in practical operation. A glass mat thus serves as carrier of the copper tracks. A glass mat thus serves as a carrier of the copper cables. In order to obtain a compact
15 construction, a majority of these glass mats with appertaining copper lines are glued together. This means that the majority of these copper tracks runs within the thus formed "layer blocks". The latter then form the actual printed board. The terminals occur at the surface side by means of through-plating.

20 At very high frequencies, such as are used in the transmission of ATM communication signals, a complementary transmission of the communication signals over a data line is controlled, as already discussed. The density of the copper cables inside the printed circuit board is extremely high. In order to construct the complementary transmission of the communication signals over a data line in a space-efficient manner, a data line is
25 respectively formed from a copper cable pair, as mentioned above. A thoroughly desirable electromagnetic coupling then occurs, since the field lines of the two cables encompass each other.

But the problem arises here that the structure of the interconnects attains the
30 dimension of the web structure. The possibility thus arises that one cable of the pair

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runs in the vicinity of the optical fiber, while the other cable of the respective pair runs in the resin itself. The two materials have different dielectricity constants, however. Since an edge-parallel leading of the copper tracks is provided in this prior art, this means that the copper tracks can run either in the vicinity of an optical fiber or in the
5 resin itself.

But this results in different signal transit times in the transmission process, both in the two copper cables of a pair and between the data lines as well. For a better understanding, the corresponding relations are illustrated in Figure 3. For example, the
10 differential amplifier, which is arranged at the end of the two copper cables of a pair and which forms the difference signal, receives the edges of the pulses which are transmitting in a complementary fashion at different instants, and on its own part it generates a potentially flat edge, or respectively, edge shift therefrom, which can no longer be used to trigger other mechanisms.

15

One solution to this problem is to use homogenous materials having one dielectricity constant. But these are expensive, however.

It is thus the object of the invention to demonstrate a way in which it is possible to
20 transmit communication signals of extremely high frequency over copper cables in printed boards of a conventional type.

The reference EP-A2-0309982 teaches a substrate material and a method for its production in that the problem of the transit time difference is solved in that the
25 substrate material that is produced with the method consists of several layers and that the fiber bundles of the individual layers are arranged at a specific angle to one another. This produces a quasi-isotropy. In any case, this reference does not contain data lines which conduct electrical signals or the arranging thereof in relation to the fiber bundles. This is unnecessary, since it is not possible for transit time differences
30 between the individual data lines to occur, due to the quasi-isotropy.

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3 a

The invention is particularly advantageous in that the data lines are no longer led edge-parallel in the appertaining glass mat material, but are rotated at a strictly specified
5 definite angle thereto. This ultimately means that the data lines are no longer led exclusively on an optical fiber, or respectively, in the resin, but run over glass, or respectively, resin in the same manner in alternation. Differences in the signal transit time thus do not arise in the transmission process. Conventional, cost-effective printed

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boards can thus also be used for transmitting high-frequency signals, which is a significant cost advantage in the variety of printed circuit boards in use today.

In accordance with one aspect of this invention,
5 there is provided a device for transmitting high-frequency communication signals, the device comprising: at least one glass fiber mat formed from a number of glass fiber bundles; and at least one dataline for conducting undesired electrical signals formed on a surface of said glass fiber
10 mat at a predetermined angle relative to said glass fiber bundles.

In accordance with another aspect of this invention, there is provided a method for manufacturing a device for transmitting high-frequency communication
15 signals, said method comprising the steps of: forming at least one glass fiber mat from a number of glass fiber bundles; and forming at least one pair of datalines for conducting electrical signals on a surface of said glass fiber mat at a predetermined angle relative to said glass
20 fiber bundles.

The invention is detailed below with the aid of an exemplifying embodiment.

Shown are:

Figure 1 the constructional structure of a glass
25 mat,

Figure 2 the side view of a glass mat,

Figure 3 the signal characteristic in the prior art.

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4a

Figure 1 depicts the constructional structure of a glass mat. Accordingly, optical fiber bundles GF are depicted, which are arranged in parallel. The optical fiber bundles GF are connected and held together by a plurality of chains K, which also consist of glass-fiber bundles. According to Figure 1, the chains K are woven about the optical fiber bundle GF with "phase positions" of 180° . In this respect, this type of structure is thoroughly similar to that of textiles. But the chains K and optical fiber bundles GF, which are arranged transversely to one another, are not only fixed mechanically; this device is also soaked in a resin that is used as an adhesive material, whereby the glass mat attains a quasi-homogenous structure. In this type of structure of glass mat, there is no privileged direction with respect to orthogonality. The two main axes are equally prioritized.

Data lines LP which conduct the complementary signals are arranged parallel to the optical fiber bundles GF according to the present exemplifying embodiment. These respectively comprise two copper cable pairs LP_a , LP_b . The paired construction of the

data lines is not absolutely required, however. Rather, a complementary transmission of electrical signals can also occur over only one data line.

Figure 2 depicts a side view of the optical fiber mat which is illustrated in Figure 1 and was just described. This depicts the optical fiber bundles GF, which are led in a parallel shape and which thus define the edges of the glass mat, or respectively, of the circuit board. In addition, data lines LP₁, LP₂ are also depicted. It is essential that the two data lines are understood as alternatives, and that as such they are not both arranged in the glass mat in this form simultaneously. This is expressed in Figure 2 by the dashed representation. The data line LP₁ consist [sic] of the copper cable pairs LP_{1a} and LP_{1b}. The data line LP₂ is formed in the same way by a copper cable pair LP_{2a} and LP_{2b}.

If all data lines of the optical fiber mat were to be led in the same manner as the data line LP₁, there would be no recognizable difference in the signal transit time at the end of a data line pair. This is attributable to the fact that the data cable LP₁ is integrated into the glass mat quasi-symmetrically, and is thus surrounded by the dielectrics of glass and resin the same way. Differences in the signal transit time compared to signals transmitted over another data line are unaffected and remain as before.

20

Problems arise in the leading of the data line LP₂ however. Here, one line of the copper cable pair LP_{2b} is led in the vicinity of the optical fibers, which have a relatively high dielectricity constant ($\xi_r = 6$). The other copper cable of this cable pair LP_{2a} runs primarily through resin, however, which has a far lower dielectricity constant ($\xi = 3$).

25

Without suitable countermeasures being taken, the signal characteristic illustrated in FIGURE 3 is fed at the receive side to the differential amplifier (not illustrated). The edges of the signals which are transmitted in a complementary manner differ by a time Δt .

In the invention, care is now taken that the data lines are led through the optical fiber mat at a specific angle to the optical fiber bundle. This angle is preferably between 0.5° and 1° . Other embodiments of this angle are also imaginable. In any case, care must be taken in the selection of the angle that the data lines are not arranged parallel to the
5 optical fibers.

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CLAIMS:

1. A device for transmitting high-frequency communication signals, the device comprising:

at least one glass fiber mat formed from a number
5 of glass fiber bundles; and

at least one dataline for conducting undesired electrical signals formed on a surface of said glass fiber mat at a predetermined angle relative to said glass fiber bundles.

10 2. The device according to claim 1, wherein the predetermined angle is an angle of between 0.5° and 1° .

3. The device according to claim 1 or 2, wherein said at least one glass fiber mat further comprises a number of said glass fiber bundles forming a printed circuit board.

15 4. The device according to claim 1 or 2, wherein said dataline further comprises a pair of datalines.

5. The device according to claim 4, wherein complementary transmission of said undesired electrical signals occurs over said pair of datalines.

20 6. A method for manufacturing a device for transmitting high-frequency communication signals, said method comprising the steps of:

forming at least one glass fiber mat from a number of glass fiber bundles; and

25 forming at least one pair of datalines for conducting electrical signals on a surface of said glass fiber mat at a predetermined angle relative to said glass fiber bundles.

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7. The method according to claim 6, wherein the predetermined angle is an angle of between 0.5° and 1° .

8. The method according to claim 6 or 7, further comprising the step of:

5 forming a printed circuit board from a number of said glass fiber mats having at least one pair of datalines formed thereon.

FETHERSTONHAUGH & CO.
OTTAWA, CANADA

PATENT AGENTS

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FIG 1

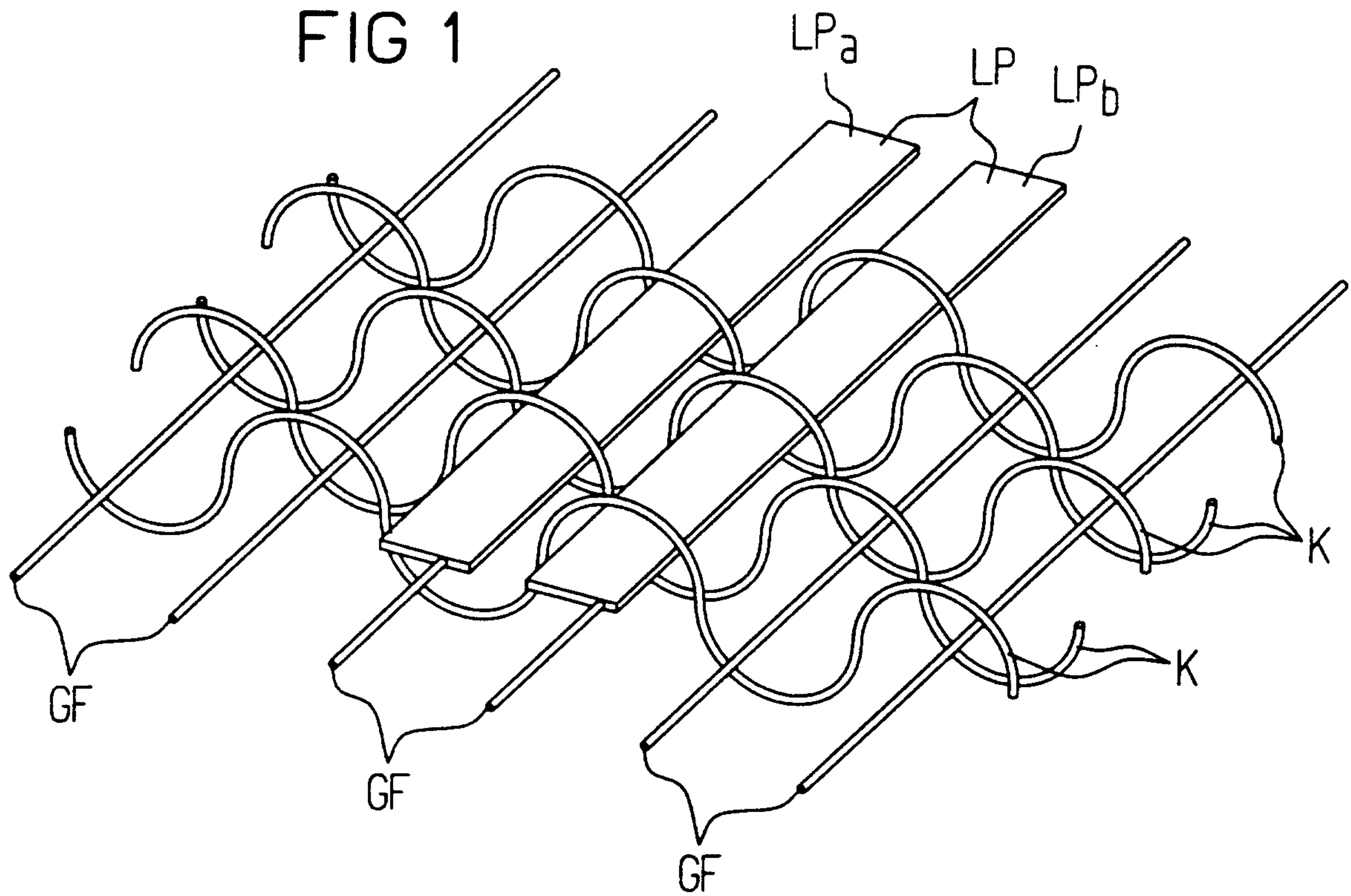
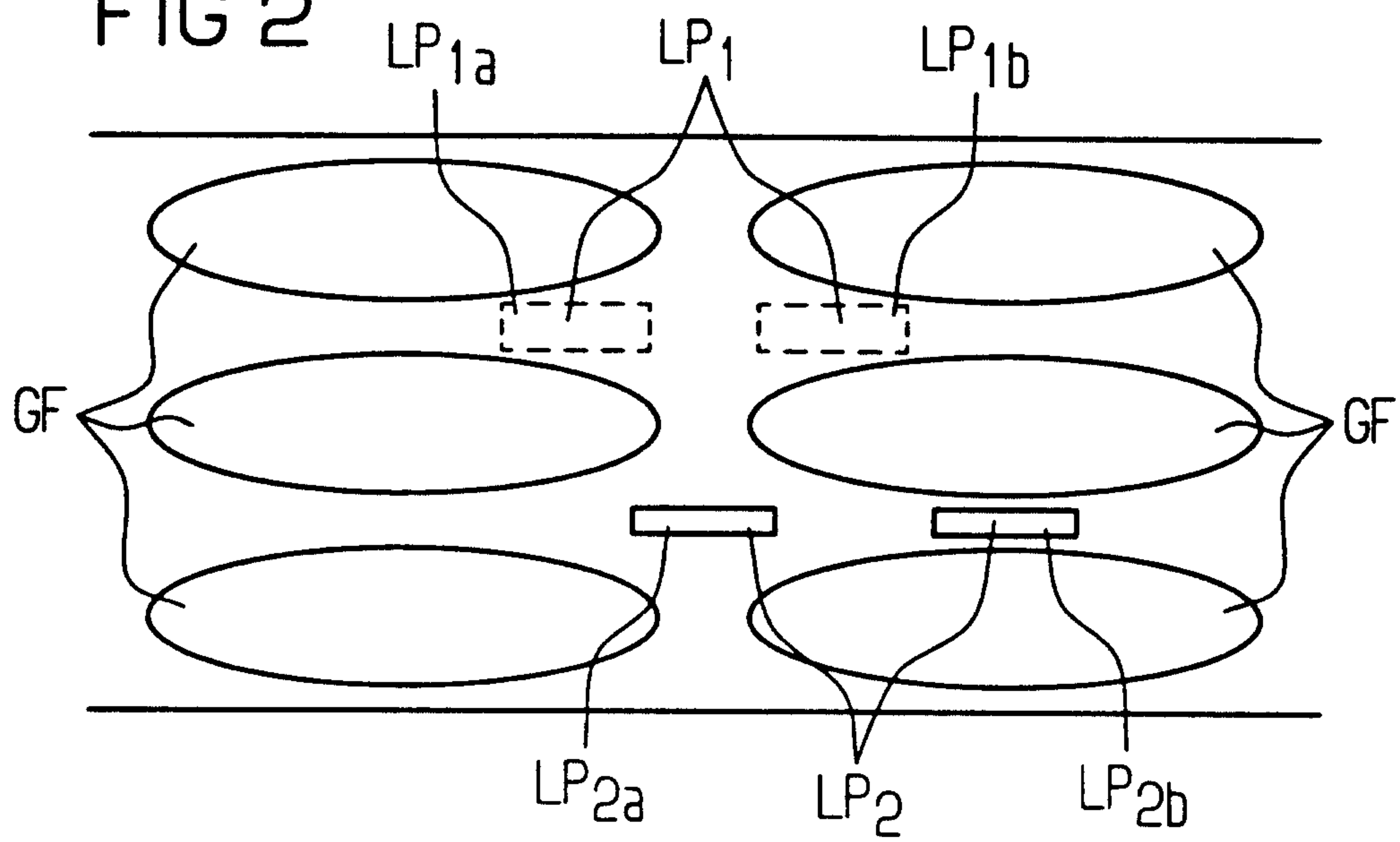


FIG 2



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FIG 3

